

# APPROVAL SHEET

AOT MODEL NAME	3006
AOT PART NUMBER	3006C-W30M
CUSTOMER NAME	General
DATE	2020 / Oct
Version	01

MAKER		CUST	OMER		
Prepared	Checked	Approved			
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## **Revision Note**

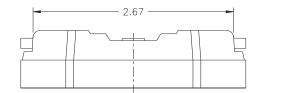
Date	Revision	Page	Version
2021-10-15	Initiate Document		01



## Package Outline

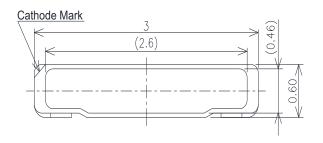
Model name: **3006C-W30M** Unit: mm, Tolerance: ± 0.1 mm



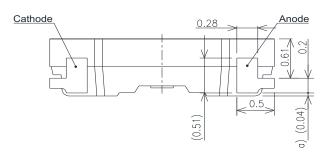




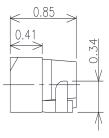




Back view

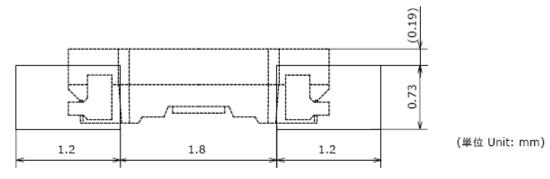


Side view





## Recommended Soldering Pad design (Unit :mm)



ltem	Materials
Package	High Temperature Resistant Plastic, PPA.
Encapsulating	Silicone Resin(with phosphor)
Electrode	Cu Alloy With Ni, Ag Plating.

- SMD type Side-View white LED.
- Lead frame package with individual 2 pins.
- Wide viewing angle(120°)
- Compatible with reflow soldering.
- Complies with RoHS Directive.
- The Encapsult surface should be under the package surface, and should not expose the wire.
- Compact package outline (L x W x H) of 3.0 mm x 0.85mm x 0.6 mm.



## **Optical/Electronic Characteristics (T<sub>A</sub>=25°C)**

Item	Symbol	Condition	Min	Тур	Max	Unit
Forward Voltage	VF	I⊧=20mA	2.7	-	3	V
Luminous Flux	Φν	I <sub>F</sub> =20mA	2.00	-	5.00	lm
Reverse Current	I <sub>R</sub>	V <sub>R</sub> = -7V	-	-	0.05	μA

\* Tolerance of measurements of the Forward Voltage is  $\pm$  0.05 V. \* Tolerance of measurements of the Luminous Flux is  $\pm$  5%.

## Absolute Maximum Ratings (T<sub>A</sub>=25°C)

Item	Symbol	Absolute Maximum Rating	Unit
Forward Current	IF	30	mA
Peak Forward Current (Duty 1/10@ 10ms)	IPF	100	
*Reverse Voltage	VR	5	V
Power Dissipation	PD	90 n	
Operating Temperature	T <sub>opr</sub>	-40~+85 °C	
Storage Temperature	T <sub>stg</sub>	-40~+100 °(	
Soldering Temperature	T <sub>sld</sub>	Reflow Soldering : 260°C for 10sec Hand Soldering : 350°C for 3sec	
Junction Temperature	Tj	105 °C	
Forward Voltage at Low Current	VF2	>1.9 ( @1 µ A ) V	

\* I\_FP Conditions: Pulse Width  $\leq$  10msec, and duty  $\leq$  1/10

\* Max condition is not guarantee for life time



#### **Group Definition of Forward Voltage**

Rank	Condition	VF(V)	
V7	T <sub>A</sub> =25°C I⊧=20mA	2.7	2.8
V8		2.8	2.9
V9		2.9	3.0

## **Group Definition of Brightness**

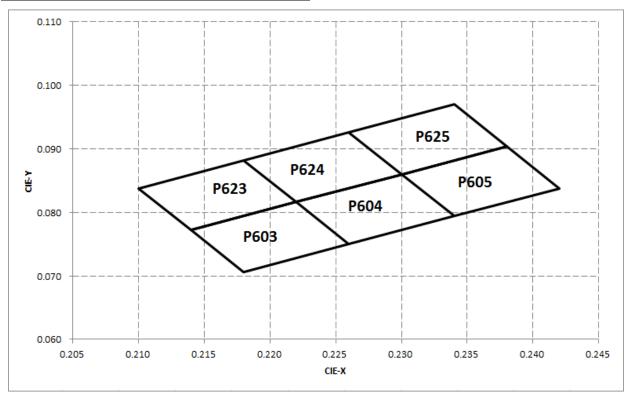
		Luminous	s Intensity	
Rank	Condition	φν(Im)		
		Min.	Max.	
NW200		2.00	2.25	
NW225		2.25	2.50	
NW250		2.50	2.75	
NW275		2.75	3.00	
NW300		3.00	3.25	
NW325	T <sub>A</sub> =25 °C	3.25	3.50	
NW350	I⊧=20mA	3.50	3.75	
NW375		3.75	4.00	
NW400		4.00	4.25	
NW425		4.25	4.50	
NW450		4.50	4.75	
NW475		4.75	5.00	

\*A shipment shall consist of LEDs in a combination of above ranks. \*The percentage of each rank in the shipment shall be determined by AOT.

\*The ranking information of LEDs can be found on the reel label.



## **Group Definition of Chromaticity Coordinate**



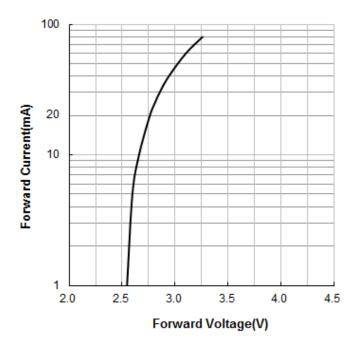
Rank	Х	Y	Rank	X	Y
	0.2100	0.0838		0.2140	0.0772
P623	0.2180	0.0882	P603	0.2220	0.0816
F023	0.2220	0.0816	F 003	0.2260	0.0750
	0.2140	0.0772		0.2180	0.0706
	0.2180	0.0882	P604	0.2220	0.0816
P624	0.2260	0.0926		0.2300	0.0860
F 024	0.2300	0.0860		0.2340	0.0794
	0.2220	0.0816		0.2260	0.0750
	0.2260	0.0926		0.2300	0.0860
P625	0.2340	0.0970	P605	0.2380	0.0904
F023	0.2380	0.0904	FUUJ	0.2420	0.0838
	0.2300	0.0860		0.2340	0.0794

If color binning is required, only one color group is allowed for each chip within a reel. Chromaticity coordinate groups are measured with an accuracy of  $\pm$  0.005

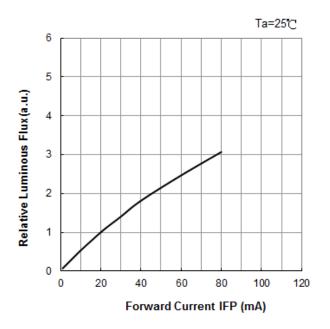


## **Optical and electrical characteristics**

#### Forward Voltage vs. Forward Current (T<sub>A</sub>= 25°C)

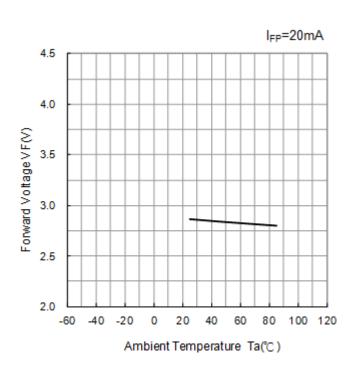


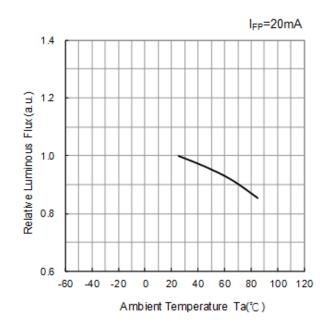
#### Forward Current vs. Relative Luminous Flux



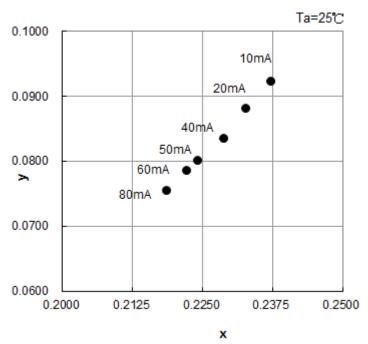
#### Ambient Temperature vs. Forward Voltage

#### Ambient Temperature vs. Relative Luminous



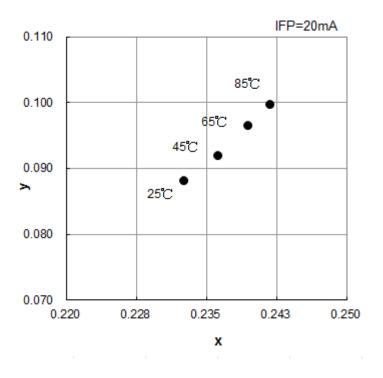






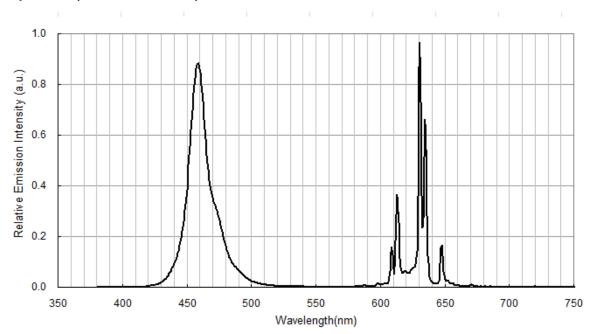
#### Forward Current vs. Chromaticity Coordinate (T<sub>A</sub>= 25°C)

Chromaticity Coordinates vs. Ambient Temperature (IFP= 20mA)





#### Spectrum (T<sub>A</sub>=25°C, I<sub>FP</sub>=20mA)



T<sub>A</sub>=25°C I<sub>FP</sub>=20mA 0° -10° 10° • X-X Y-Y -20° 20° -30° -30° γ 40° Х Х -40° 50° -50° 放射角度 Radiation Angle -60° 60° -70° 70° 80° -80° -90° 90° 0.5 0.5 0 1 1 相対照度 Relative Illuminance(a.u.)

#### **Radiation Pattern**



## **Recommended Reflow Soldering Conditions**

#### Surface Mounting Condition

In automatic mounting of the SMD LEDs on printed circuit boards, any bending, expanding and pulling forces or shock against the SMD LEDs should be kept min. to prevent them from electrical failures and mechanical damages of the devices.

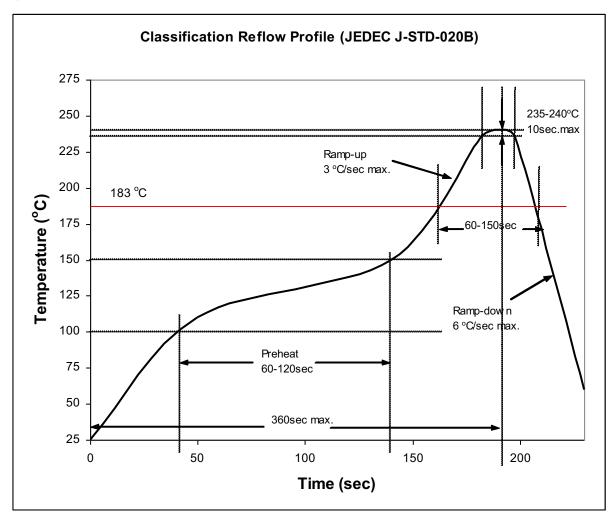
#### Soldering Reflow

-Soldering of the SMD LEDs should conform to the soldering condition in the individual specifications.

- -SMD LEDs are designed for Reflow Soldering.
- -In the reflow soldering, too high temperature and too large temperature gradient such as rapid heating/ cooling may cause electrical & optical failures and damages of the devices.

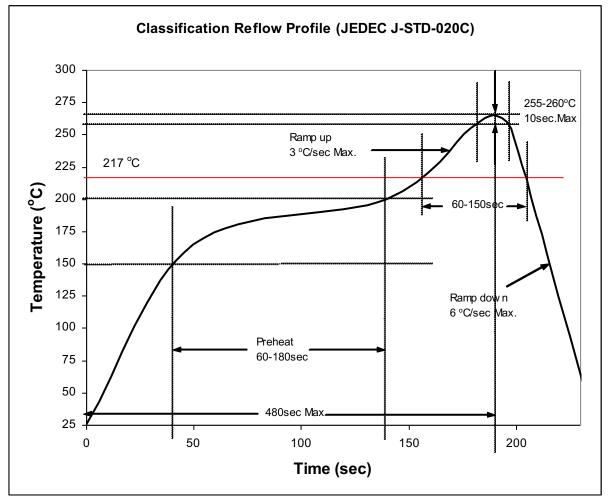
-AOT cannot guarantee the LEDs after they have been assembled using the solder dipping method.

#### 1) Lead Solder





#### 2) Lead-Free Solder



#### 3) Manual Soldering Conditions

- Lead Solder

Max. 300 °C for Max. 3sec, and only one time.

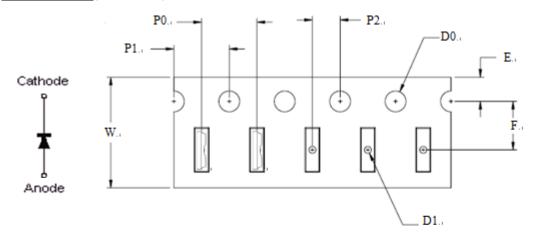
- Lead-free Solder

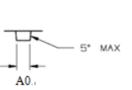
Max. 350 °C for Max. 3sec, and only one time.

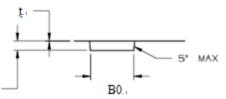
- There is possibility that the brightness of LEDs is decreased, which is influenced by heat or ambient atmosphere during reflow. It is recommended to use the nitrogen reflow method.
- After LEDs have been soldered, repair should not be done. As repair is unavoidable, a double-head soldering iron should be used. It should be confirmed beforehand whether the characteristics of the LEDs will be damaged by repairing or not.
- Reflow soldering should not be done more than two times.



## Dimensions (Unit :mm)





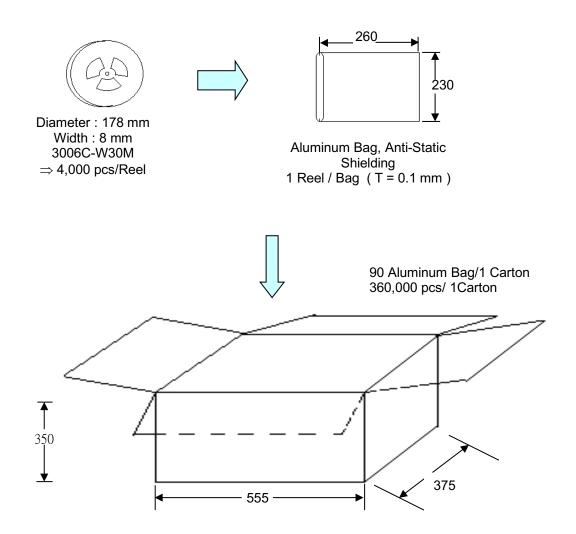


ltem	Spec.	Tolerance(mm)	Item	Spec.	Tolerance(mm)
W	8.00	+0.3/-0.1	P2	2.00	±0.05
E	1.75	±0.10	P0x10	40.0	-
F	3.50	±0.05	t	0.20	±0.05
D0	1.50	+0.10/-0.00	A0	0.95	±0.05
D1	0.5	+0.05/-0.00	B0	3.11	±0.05
P0	4.00	±0.10	K0	0.55	±0.05
P1	2.00	±0.05			

K0.,

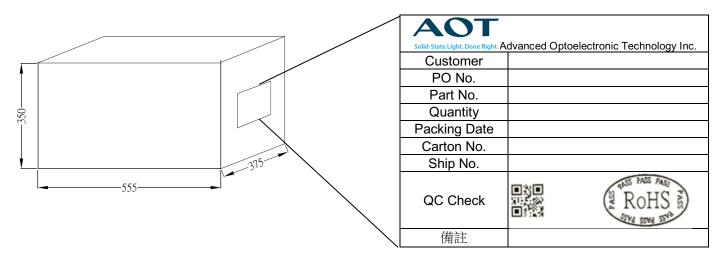


## **Packing Formation**





## Package Outlook:



## **Reel Label Definition**

		SAP. No.
SMD LED		
Part Numbe	r : 3006C-W309	
Brightness	: A	
CIE	: B	
VF	: C	
Quantity	: nn ea	
Serial No	: SM0yymmddxxxx	
Cust. PN.	: XXXXX-XXXX	

- A : Iv value
- B : CIE value noted,
- C: Vf value,
- nn : Quantity of LED

SM0yymmddxxx : yy : year, mm : month, dd : day, xxxx : reel no

\*Reel Label to fill in practice data of all LED characteristic



## Reliability Test

No.	Test Item	Standard Test Method	Test Condition	Note	Number of Damaged
1	Room Temp. Life Test	Internal Ref.	T <sub>A</sub> =25℃,I⊧=20mA	1000hrs	0/20
2	High Temp. Operating	JESD22-A108	T <sub>A</sub> =65℃,I⊧=20mA	1000hrs	0/20
3	High Temp. Operating	JESD22-A108	T <sub>A</sub> =85℃,I⊧=8.5mA	1000hrs	0/20
4	High Temp. Storage	JESD22-A103	T <sub>A</sub> =100℃	1000hrs	0/20
5	Low Temp. Operating	JESD22-A108	T <sub>A</sub> =-40°C,I⊧=20mA	1000hrs	0/20
6	High Temp. and High Humidity Operation	JESD22-A119	60°C 95%RH, I⊧ =20mA	1000hrs	0/20
7	Temperature and humidity cycle test	IEC68-2-38	25°C ~65°C ~-10°C,90% RH 24hr per cycle	10 cycle	0/20
8	Thermal Cycle Test	JESD22-A106	100°C 30min∼ -40°C 30min Transform time 5min	300cycles	0/20

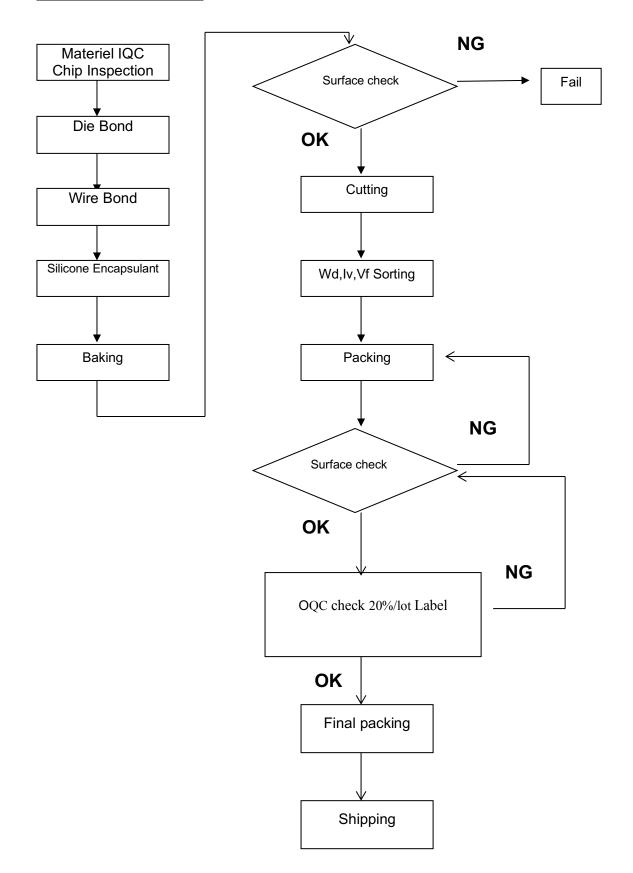
## Criteria for Judging Damage

Item	Symbol	Test Conditions	Criteria for Judgement	
			Min.	Max.
Forward Voltage	VF	IF =20mA	-	*U.S.L×1.1
Reverse Current	lr	V <sub>R</sub> =5V	-	*U.S.L×2.0
Luminous Intensity	lv	I⊧ =20mA	*L.S.L×0.7	-

\* U.S.L: Upper Standard Level \* L.S.L: Lower Standard Level



## Side View Process Flow





#### CAUTIONS

(1) Moisture Proof Package

The moisture proof package should be used to prevent moisture in the package as the moisture may Cause damage to optical characteristics of the LEDs.

The aluminum bag with zipper is used for moisture proof package. And, the moisture absorbent Material, Silica gel, is inserted into aluminum bag.

(2) Storage:

Storage Conditions

Before opening the package:

The LEDs should be kept at 30°C or less than 90%RH or less. The LEDs should be used within a year. When storing the LEDs, moisture proof packaging with absorbent material is recommended. After opening the package:

After open the package, the LED should be kept at 30°C, 60%RH or less. The LED should be soldered within 168 hours (7 days) after opening the package. If unused LEDs remain, it should be stored in moisture proof condition.

(3) Heat Generation

Thermal design of the end products is of paramount importance. The heat generation must be taken into design consideration when using the LED. The coefficient of the temperature increase per input electric power is affected by the thermal resistance of the circuit board and density of LED placement on the board, as well as other components.

(4) Static Electricity

Static electricity or surge voltage damages the LEDs. All equipment and machinery must be properly grounded. It is recommended to use a wristband or anti-electrostatic glove when handing the LEDs. When inspecting the final products in which LEDs were assembled, it is recommended to check whether the assembled LEDs are damaged by static electricity or not. It is easy to find static-damaged LEDs by a light-on test or a Vf test at a lower current. (Below 1mA is recommended). Criteria: Vf >1.9V at If=1  $\mu$  A

(5) Cleaning

Use isopropyl alcohol as a solvent for cleaning the LEDs. The other solvent may dissolve the LEDs package and the epoxy.

Ultrasonic cleaning should not be done.

(6) Electrostatic Discharge (ESD)

The products are sensitive to static electricity or surge voltage, An ESD event may damage its die or reduce its reliability performance. When handling the products, measures against electro static discharge, including the followings, are strongly recommended.

Eliminating the charge;

Wrist strap, ESD footwear and garments, ESD floors



Grounding the equipment and tools at workstation

ESD table / shelf mat (conductive materials)

Proper grounding techniques are required for all devices, equipment and machinery used in the assembly of the products, Also note that surge protection should be considered in the design of customer products.

If tools or equipment contain insulating materials, such as glass or plastic, proper measures against electro static discharge, including the followings are strongly recommended.

Dissipating the charge with conductive materials

Preventing the charge generation with moisture

Neutralizing the charge with ionizer

#### (7) Others

When using the LEDs, it must care that the reverse voltage will not exceed the absolute maximum rating. The LED light is enough to injure human eyes, so it should avoid looking at LED light directly.

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